## $\chi_{\text {QueLighting }}$



## Product Outline:

These high output reflector type Tube LEDs are available in warm white /neutral white / pure white / and cold white to suit customer's application. These LEDs are equipped with heat sink to enhance operating performance. With special binning technology, these LEDs are ideal for architecture lighting and special lighting needs.

## Features:

- High brightness output @ 65mA
- Package Dimension = 3.0mmX1.4mmX0.65mm
- CRI = 80 and above
- Available in warm white / neutral white / pure white / and cold white
- ASNI Binning
- RoHS compliant
- Custom Bin available upon special request


## Application:

- Architecture Lighting
- Security / garden lighting
- Interior Lighting
- General lighting


## Compliance and Certification:



## Mechanical Property:

(Dimension)


* All dimensions are in millimeters, * Tolerances are $\pm 0.10 \mathrm{~mm}$.


## Recommended Solder footprint:



* All dimensions are in millimeters.
* The LEDs is designed to be reflow soldered on to a PCB. IF dip soldered that QL cannot guarantee its reliability.
* Reflow soldering must not be performed more than twice.


## Characteristics

- Absolute Maximum Ratings
( $\mathbf{T a}=25^{\circ} \mathrm{C}$ )

| Parameter | Symbol | Rating | Unit |
| :---: | :---: | :---: | :---: |
| DC Forward Current | If | 150 | mA |
| Power Dissipation | Pd | 0.5 | W |
| Pulse Forward Current | Ifp | 200 | mA |
| LED Junction Temperature | TJ | 120 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | Tstg | $-40 \sim 100$ | ${ }^{\circ} \mathrm{C}$ |
| Operation Temperature | Topr | $-40 \sim 85$ | ${ }^{\circ} \mathrm{C}$ |
| Soldering Temperature | Tsol | $260<5 \mathrm{sec}$ | ${ }^{\circ} \mathrm{C}$ |

(1) Proper current rating must be observed to maintain junction temperature below maximum at all time
(2) IfP Condition: $\mathrm{t}<100 \mu \mathrm{~s} ; \mathrm{D}=0.001$; $\mathrm{Ta}=25^{\circ} \mathrm{C}$

- Electrical / Optical Characteristic
(Ta=25 oC)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Forward Voltage | Vf | 65mA | 2.8 |  | 3.4 | V |
| Color Rendering Index | Ra |  | 80 |  |  |  |
| View Angle | $\theta$ |  |  | 120 |  | deg |
| Thermal Resistance | Rth |  |  | 45 |  | oC/W |

(1) Tolerance of measurement: $\mathrm{VF}=+/-0.1 \mathrm{~V}$
(2) The CRI tolerance is $\pm 2$.
(3) Thermal resistance is calculated from junction to solder

## - Specification

Chromaticity Coordinates


| ANSI | Color Space | Target Center point <br> (cx,cy) | Major <br> Axis,a | Minor <br> Axis,b | Ellipse <br> Rotation Angle |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 2700 K | 3-step MacAdam <br> ellipse | $(0.4578,0.4101)$ | 0.0081 | 0.0042 | $53.70^{\circ}$ |
| 2700 K | 5-step MacAdam <br> ellipse | $(0.4578,0.4101)$ | 0.0135 | 0.007 | $53.70^{\circ}$ |
| 3000 K | 3-step MacAdam <br> ellipse | $(0.4338,0.403)$ | 0.0083 | 0.00408 | $53.22^{\circ}$ |
| 3000 K | 5-step MacAdam <br> ellipse | $(0.4338,0.403)$ | 0.0139 | 0.0068 | $53.22^{\circ}$ |
| 4000 K | 3-step MacAdam <br> ellipse | $(0.3818,0.3797)$ | 0.0094 | 0.00402 | $53.72^{\circ}$ |
| 4000 K | 5-step MacAdam <br> ellipse | $(0.3818,0.3797)$ | 0.0157 | 0.0067 | $53.72^{\circ}$ |


| 5000 K | 3-step MacAdam <br> ellipse | $(0.3447,0.3553)$ | 0.0082 | 0.00354 | $59.62^{\circ}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 5000 K | 5-step MacAdam <br> ellipse | $(0.3447,0.3553)$ | 0.0137 | 0.0059 | $59.62^{\circ}$ |
| 5700 K | 3-step MacAdam <br> ellipse | $(0.3287,0.3417)$ | 0.0075 | 0.0032 | $59.09^{\circ}$ |
| 5700 K | 5-step MacAdam <br> ellipse | $(0.3287,0.3417)$ | 0.0124 | 0.00533 | $59.09^{\circ}$ |
| 6500 K | 3-step MacAdam <br> ellipse | $(0.3123,0.3282)$ | 0.0067 | 0.00285 | $58.57^{\circ}$ |
| 6500 K | 5-step MacAdam <br> ellipse | $(0.3123,0.3282)$ | 0.0112 | 0.00475 | $58.57^{\circ}$ |

## CIE binning code



Forward Voltage ( $\mathrm{V}_{\mathrm{F}}$ ) Bin:

| VF Rank @ 65mA |  |  |  |
| :---: | :---: | :---: | :---: |
| Code name | Min. | Max. | Units |
| 0 | 2.8 | 2.9 |  |
| 1 | 2.9 | 3.0 |  |
| 2 | 3.0 | 3.1 | V |
| 3 | 3.1 | 3.2 |  |
| 4 | 3.2 | 3.3 |  |
| 5 | 3.3 | 3.4 |  |

The forward voltage tolerance is $\pm 0.1 \mathrm{~V}$

## Luminous Intensity Bin:

| Intensity Rank (mcd) @ 65mA |  |  |  |
| :---: | :---: | :---: | :---: |
| Code name | Min. | Max. | Units |
| QK | 22.5 | 25 |  |
| QL | 25 | 28 | Im |
| QM | 28 | 31.5 |  |
| QN | 31.5 | 36 |  |

Luminous intensity tolerance is $\pm 7 \%$

- Characteristic Curves
(1) Color Spectrum

(2). Typical Representative Spatial Radiation Pattern



## (3). Forward Current vs Relative Luminous Intensity


(4). Forward Current vs Forward Voltage


## ■ Reliability test:

| No | Item | Condition | Time/Cycle | Sample size |
| :---: | :---: | :---: | :---: | :---: |
| 1 | Steady State Operating Life of Room Temperature | $25^{\circ} \mathrm{C}$ Operating | 1000 Hrs | 20 pcs |
| 2 | Steady State Operating Life of Low Temperature $-40^{\circ} \mathrm{C}$ | $-40^{\circ} \mathrm{C}$ Operating | 1000 Hrs | 20 pcs |
| 3 | Steady State Operating Life of Low Temperature $60^{\circ} \mathrm{C}$ | $60^{\circ} \mathrm{C}$ Operating | 1000 Hrs | 20 pcs |
| 4 | Steady State Operating Life of Low Temperature $85^{\circ} \mathrm{C}$ | $85^{\circ} \mathrm{C}$ Operating | 1000 Hrs | 20 pcs |
| 5 | Low temperature storage $-40^{\circ} \mathrm{C}$ | $-40^{\circ} \mathrm{C}$ Storage | 1000 Hrs | 20 pcs |
| 6 | High temperature storage $100^{\circ} \mathrm{C}$ | $100^{\circ} \mathrm{C}$ Storage | 1000 Hrs | 20 pcs |
| 7 | Steady State Operating Life of High Humidity Heat $60^{\circ} \mathrm{C} 90 \%$ | $60^{\circ} \mathrm{C} / 90 \%$ Operating | 1000 Hrs | 20 pcs |
| 8 | Steady State Pulse Operating Life Condition | $25^{\circ} \mathrm{C} 10 \mathrm{~Hz}$ duty $=1 / 10$ Operating | 200 Cycle | 20 pcs |
| 9 | Resistance to soldering heat on PCB (JEDEC MSL3) | pre-store@ $60^{\circ} \mathrm{C}, 60 \% \mathrm{RH}$ for 52hrs Tsld max.=260 10sec | 3 Times | 20 pcs |
| 10 | Heat Cycle Test (JEDEC MRC) | $\begin{gathered} 25^{\circ} \mathrm{C} \sim 65^{\circ} \mathrm{C} \sim-10^{\circ} \mathrm{C}, 90 \% \mathrm{RH}, \\ 24 \mathrm{hr} / 1 \mathrm{cycle} \end{gathered}$ | 10 Cycle | 20 pcs |
| 11 | Thermal shock | $-40^{\circ} \mathrm{C} / 20 \operatorname{minr} \sim 5 \operatorname{minr} \sim 100^{\circ} \mathrm{C}$ | 300 Cycle | 20 pcs |

## - Judgment Criteria:

| Item | Symbol | Test Condition | Judgment <br> Criteria |
| :---: | :---: | :---: | :---: |
| Forward Voltage | Vf | 65 mA | $\triangle \mathrm{Vf}<10 \%$ |
| Luminous Flux | Iv | 65 mA | $\triangle \mathrm{~V}<30 \%$ |

## - Solder Profile:

-The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):


■ Taping \& Packing:


| Item | Spec | Tol.(+/- ) | Item | Spec | Tol.(+/- ) |
| :---: | :---: | :---: | :---: | :---: | :---: |
| W | 8.00 | $\pm 0.1$ | P2 | 2.00 | $\pm 0.05$ |
| E | 1.75 | $\pm 0.1$ | P0 $\times 10$ | 40.00 | $\pm 0.2$ |
| F | 3.50 | $\pm 0.05$ | tI | 0.23 | $\pm 0.05$ |
| D | 1.50 | $+0.1,-0$ | A0 | 1.55 | $\pm 0.1$ |
| DI | 1.00 | $\pm 0.1$ | B0 | 3.20 | $\pm 0.1$ |
| P0, PI | 4.00 | $\pm 0.1$ | K0 | 0.95 | $\pm 0.1$ |

Unit : mm


Maximum 5 bags
in 1 inner box
Inner box dimension $=290 \mathrm{~mm} \times 240 \mathrm{~mm} \times 70 \mathrm{~mm}$


- Labeling


## QueLighting

Quelighting P/N: XXXXXX

Lot number: XXXXX
Iv Bin: XX Color Bin: XX Vf Bin: XX Date Code: XXXX

- Ordering Information:

| Part \# | Multiple Quantities | Quantity per Reel |
| :---: | :---: | :--- |
| QLSP01WXL-190 |  | $2000 / 4000 \mathrm{pcs}$ |
|  |  |  |
|  |  |  |
|  |  |  |

## - Revision History:

| Revision Date: | Changes: | Version \#: |
| :--- | :--- | :--- |
| $02-27-2018$ | Initial release | 1.0 |
| $09-23-2019$ | Updated the performance | 1.1 |
|  |  |  |
|  |  |  |

